

# SOM-COM-HPC-A-RPL

COM HPC® Client module Size A, with 13th Gen Intel® Core™ processors (Codename: Raptor Lake – H/P/U series)

# 13th Gen Core-i processing with AI accelerator for high performance industrial grade edge applications



#### HIGHLIGHTS

13th Gen Intel® Core™ processors (Codename: Raptor Lake – H/P/U series)

Intel® Iris® Xe Architecture with up to 96

EUs, up to 4 independent displays



### CONNECTIVITY

2x 2.5GbE; 4x USB4.0 / USB 3.2; 4x USB2.0; 8x PCle x1 Gen3, 1x PCle x8 or 2x PCle x4 Gen4; Optional on-board WiFi 6E + BT 5.2



Two DDR5 SO-DIMM Slots supporting DDR5-4800 Memory





















#### MAIN FIELDS OF APPLICATION













Up to 8x PCle x1 Gen3 lanes



Coffee & Vending

Medical

Transportation

Safety & Surveillance

Industrial **Automation** 

**Smart Devices** 

## Digital Signage

#### FEATURES

**USB** 

Processor	13th Gen Intel® Core <sup>TM</sup> processors, up to 14 cores & up to 20 threads, up to 24MB cache, 15/45W TDP
Memory	2x DDR5-4800 SODIMM Slots, up to 64GB
Graphics	Integrated Iris® X® Architecture, up to 96 Execution Units Up to two video decode boxes (VDBoxes) for enhanced video stream capabilities Support for up to 48 simultaneous 1080p streams ingestion Support for up to four independent displays at up to 4K60 HDR resolution or one display at 8K resolution
Video Interfaces	Up to 3x DDI ports supporting DP 1.4, HDMI 2.0b (HDMI 2.1 via LSPCON) Up to 2x DP++ interfaces over USB 4.0 (Factory alternatives to 2x DDI ports) 1x eDP 1.4b interface
Video Resolution	DP Up to 5120x3200 @60Hz 24bpp / 7680x4320@60Hz 30bpp with DSC eDP: Up to 5120x3200 @60Hz 24bpp / 5120x3200@120Hz 30bpp with DSC HDMI® 1.4: Up to 4Kx2K 24-30Hz 24bpp / 4Kx2K 48-60Hz 12bpc (need dedicated redriver on carrier board)
Mass Storage	2x external SATA Gen3 Channels PCI-e x4 ports can be used to connect, on the carrier board, M.2 NVMe drives
문 Networking	2x NBase-T Ethernet interfaces, supporting 2.5Gb Ethernet connection, managed by as many Intel® i225 2.5GbE Controllers Optional on-board M.2 1216 module, supporting WiFi 802.1lax (WiFi 6E) MIMO 2x2 + MU-MIMO and Bluetooth 5.2, external antennas*
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Up to 4 x USB 4.0 / USB 3.2 Host ports

4 x USB 2.0 Host port

:==:	PCI-e	lx PCIe x8 Gen4 port 2x PCIe x4 Gen4 ports
ilii	Audio	SoundWire and I2S Audio Interface
<u>•••••</u> •	Serial Ports	2 x UARTs
	Other Interfaces	2x 4-lane CSI-2 interfaces SPI, SM Bus, 2x I2C, Watchdog timer, Carrier board FAN Control Management signals, ACPI signals, Safety Status signals Deep Sleep / Battery support Optional TPM 2.0 module on-board I2x GPIOs
	Other	Al engine: Intel® Gaussian & Neural Accelerator 3.0 (Intel® GNA) Can operate while the SOC is in lower power states
	Power Supply	$+8V_{\rm DC}+20V_{\rm DC}$ Main power supply $+5V$ stand-by
os	Operating System	Windows 10 IoT Enterprise LTSC Windows Server 2022 Wind River VxWorks 7.0 Linux Kernel LTS (Ubuntu) Wind River Linux Yocto Android
1	Operating Temperature*	-40°C ÷ +85°C (Industrial)
L	Dimensions	120 x 95 mm (COM-HPC® Size A Form factor, Client pinout)

\*Measured at any point of SECO standard heatspreader for this product, during any and all times (including start-up). Actual temperature will widely depend on application, enclosure and/or environment. Upon customer to consider application-specific cooling solutions for the final system to keep the heatspreader temperature in the range indicated.



#### BLOCK DIAGRAM



